LNJ814K8SRA

Surface Mounting Chip LED

USS Type

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Power dissipation	P_{D}	40	mW	
Forward current	I_{F}	15	mA	
Pulse forward current *	I_{FP}	50	mA	
Reverse voltage	V_R	3	V	
Operating ambient temperature	T _{opr}	-30 to +85	°C	
Storage temperature	T _{stg}	-40 to +100	°C	

Note) *: The condition of I_{FP} is duty 10%, Pulse width 1 msec.

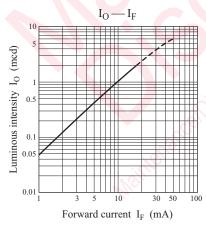
■ Lighting Color

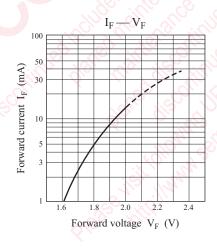
• Soft Orange

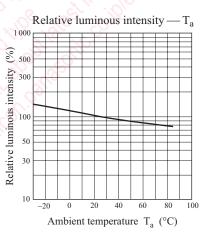
■ Electro-Optical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

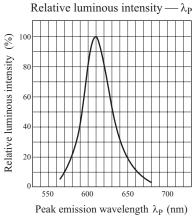
Parameter	Symbol		Conditions	Min	Тур	Max	Unit
Luminous intensity *	I_{O}	$I_F = 10 \text{ mA}$	0100	0.5	1.0		mcd
Reverse current	I_R	$V_R = 4 V$	igur			10	μΑ
Forward voltage	V _F	$I_F = 10 \text{ mA}$	30, 100		1.93	2.6	V
Peak emission wavelength	$\lambda_{ m P}$	$I_F = 10 \text{ mA}$	William Child		610	Jilo.	nm
Spectral half band width	Δλ	$I_F = 10 \text{ mA}$	10 30, ONE 11/03	180	40		nm

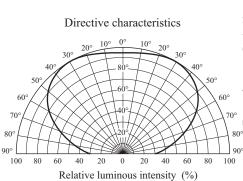
Note) *: Measurement tolerance: ±20%

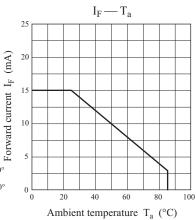








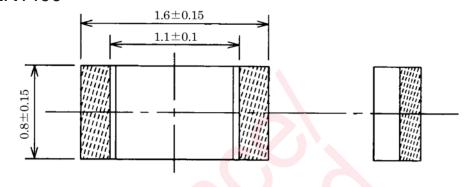


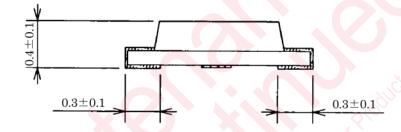


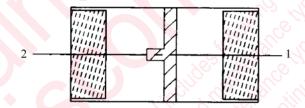
LNJ814K8SRA Panasonic

■ Package (Unit: mm)

KLTFTN2K1400







- Pin name
 - 1: Anode
 - 2: Cathode

2 SHD00670BEK

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